



ZHCS506Q

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

### Product Summary (@ T<sub>A</sub> = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> (mA)	V <sub>F(MAX)</sub> (mV)	I <sub>R(MAX)</sub> (μA)
60	500	630	40

# Applications

- DC DC Converters
- Mobile Telecomms
- PCMIA

## **Features and Benefits**

- High Current Capability (I<sub>O</sub> = 500mA)
- Low V<sub>F</sub>
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0089 grams (Approximate)



Top View



Anode 3

NC 2

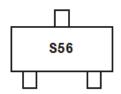
## Ordering Information (Note 5)

Device	Packaging	Shipping
ZHCS506QTA	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



S56 = Product Type Marking Code



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Continuous Reverse Voltage		V <sub>RRM</sub>	60	V
Continuous Forward Current		lo	500	mA
Forward Voltage @I <sub>F</sub> =500mA		V <sub>F</sub>	630	mV
Average Peak Forward Current; D.C. = 50%		I <sub>FAV</sub>	1000	mA
Non Repetitive Forward Current	t ≤ 100µs		5.5	Α
	$t \leq 10 ms$	IFSM	2.5	A

## **Thermal Characteristics**

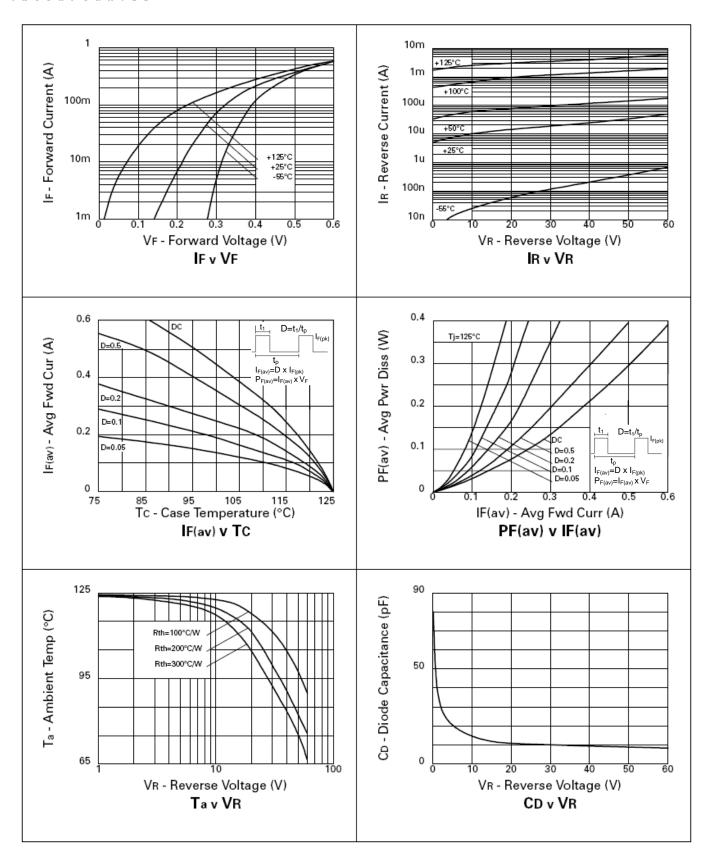
Characteristic	Symbol	Value	Unit
Power Dissipation, T <sub>A</sub> = +25°C	P <sub>D</sub>	330	mW
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

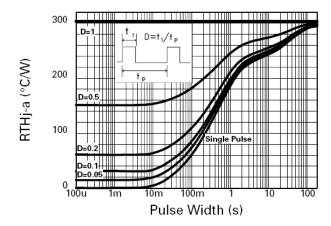
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	60	80	_	V	$I_R = 200 \mu A$
		_	275	310		I <sub>F</sub> = 50mA
		_	320	360		I <sub>F</sub> = 100mA
		_	415	470		I <sub>F</sub> = 250mA
Famuard Valtage (Note 6)		_	550	630		I <sub>F</sub> = 500mA
Forward Voltage (Note 6)	VF	_	680	800	mV	I <sub>F</sub> = 750mA
		_	820	960		I <sub>F</sub> = 1A
		_	1120	1350		I <sub>F</sub> = 1.5A
		_	565	_		I <sub>F</sub> = 500mA, T <sub>A</sub> = +100°C
Reverse Current	I <sub>R</sub>		20	40	μΑ	V <sub>R</sub> = 45V
Diode Capacitance	C <sub>D</sub>	_	20	_	pF	f = 1MHz, V <sub>R</sub> = 25V
				_	ns	Switched from I <sub>F</sub> = 500mA to
Reverse Recovery Time	t <sub>RR</sub>	_	10			$I_R = 500 \text{mA}$
						Measured @ I <sub>R</sub> = 50mA

Note: 6. Measured under pulsed conditions. Pulse width =  $300\mu$ S. Duty cycle 2%.





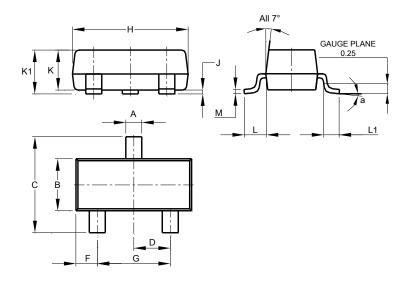




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23



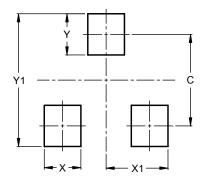
SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Ι	2.80	3.00	2.90		
7	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
١	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					



## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)		
С	2.0		
Х	0.8		
X1	1.35		
Y	0.9		
Y1	2.9		

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